

62mm Half Bridge IGBT Module

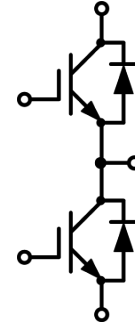
$V_{CES} = 1700V$, $I_C = 150A$, $V_{CE(sat)} = 1.93V$

Features

- 1700V Trench/Field Stop Technology
- Low switching losses
- V_{cesat} has a positive temperature coefficient

Applications

- Power Converters
- Uninterruptible power supplies
- Servo Drives
- Inverter



IGBT, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Collector-Emitter voltage	V_{CES}	$T_{vj}=25^{\circ}C$	1700	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=100^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	150	A
Repetitive peak collector current	I_{CRM}	$t_p=1ms$	300	A
Total power dissipation	P_{tot}	$T_C=25^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	1071	W
Gate-Emitter voltage	V_{GE}		± 20	V

Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	V_{CEsat}	$V_{GE}=15V$, $I_C=150A$ $V_{GE}=15V$, $I_C=150A$ $V_{GE}=15V$, $I_C=150A$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	1.93 2.25 2.34	2.35	V
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C=6mA$, $V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	4.90	5.50	6.10
Internal gate resistor	R_{Gint}			4.30		Ω
Input capacitance	C_{ies}	$f=1MHz$, $V_{CE}=25V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	17.20		nF
Reverse transfer capacitance	C_{res}	$f=1MHz$, $V_{CE}=25V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	0.50		nF
Collector-Emitter cut-off current	I_{CES}	$V_{CE}=1700V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$		1	mA
Gate-Emitter leakage current	I_{GES}	$V_{CE}=0V$, $V_{GE}=20V$	$T_{vj}=25^{\circ}C$		150	nA
Turn-on delay time	t_{don}	$I_C=150A$, $V_{CE}=900V$ $V_{GE}=\pm 15V$, $R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	189 221 234		ns

Rise time	t_r	$I_C=150A, V_{CE}=900V$ $V_{GE}=\pm 15V, R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		55 61 63		
Turn-off delay time	$t_{d\ off}$	$I_C=150A, V_{CE}=900V$ $V_{GE}=\pm 15V, R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		419 491 505		ns
Fall time	t_f	$I_C=150A, V_{CE}=900V$ $V_{GE}=\pm 15V, R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		335 417 436		
Turn-on energy loss per pulse	E_{on}	$I_C=150A, V_{CE}=900V$ $V_{GE}=\pm 15V, R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		29.92 40.98 45.47		mJ
Turn-off energy loss per pulse	E_{off}	$I_C=150A, V_{CE}=900V$ $V_{GE}=\pm 15V, R_G=4.8\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$		28.64 35.68 38.29		
SC data	I_{SC}	$V_{GE}\leq 15V, V_{CE}=1000V$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt,$ $t_p\leq 10\mu s,$	$T_{vj}=150^\circ C$		800		A
Thermal resistance, junction to case	$R_{th\ JC}$	per IGBT				0.14	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40		150	$^\circ C$

Diode, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^\circ C$	1700	V
Continuous DC forward current	I_F		150	A
Repetitive peak forward current	I_{FRM}	$t_p=1ms$	300	A
I^2t value	I^2t	$t_p=10ms, \sin 180^\circ, T_{vj}=125^\circ C$	7000	A^2s

Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F=150A, V_{GE}=0V$ $I_F=150A, V_{GE}=0V$ $I_F=150A, V_{GE}=0V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	2.18 2.33 2.35	2.70	V
Peak reverse recovery current	I_{RM}	$I_F=150A$ $-di_F/dt=1650A/\mu s(T_{vj}=150^\circ C)$ $V_R=900V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	93 106 108		A
Recovered charge	Q_r	$I_F=150A$ $-di_F/dt=1650A/\mu s(T_{vj}=150^\circ C)$ $V_R=900V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	23.20 40.90 44.50		μC
Reverse recovered energy	E_{rec}	$I_F=150A$ $-di_F/dt=1650A/\mu s(T_{vj}=150^\circ C)$ $V_R=900V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	12.63 23.34 25.21		mJ
Thermal resistance, junction to case	$R_{th\ JC}$	per diode			0.16	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40	150	$^\circ C$

Characteristics Values(Module)

Parameter	Symbol	Test Condition	Value	Unit
Isolation test voltage	V _{ISOL}	RMS, f=50Hz, t=1min	4000	V
Internal isolation			Al ₂ O ₃	
Storage temperature	T _{stg}		-40	125 °C
Mounting torque for module mounting	M		3.0	6.0 Nm
Weight	W		316	g

Typical Characteristics

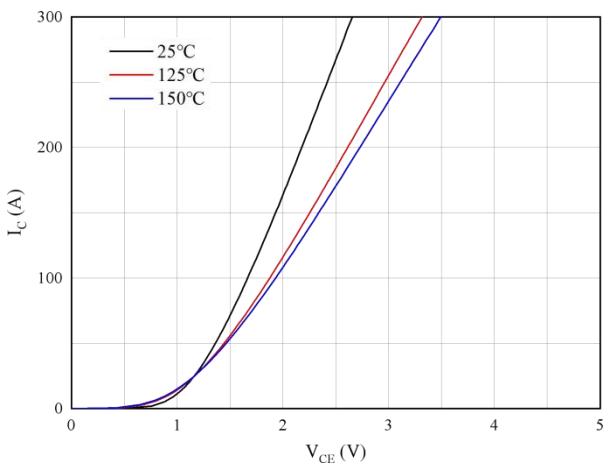


Fig 1. Typical output characteristics ($V_{GE}=15V$)

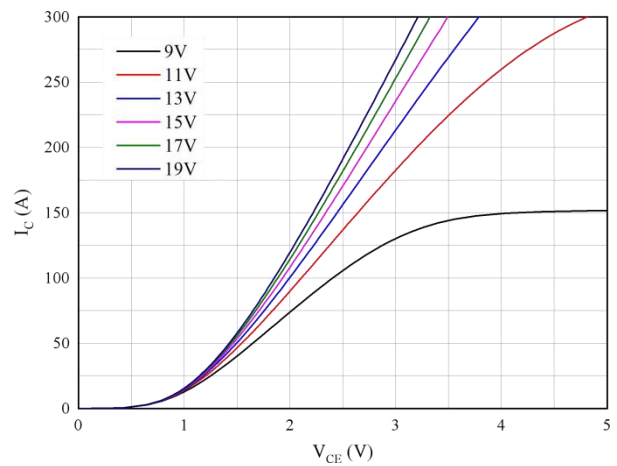


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

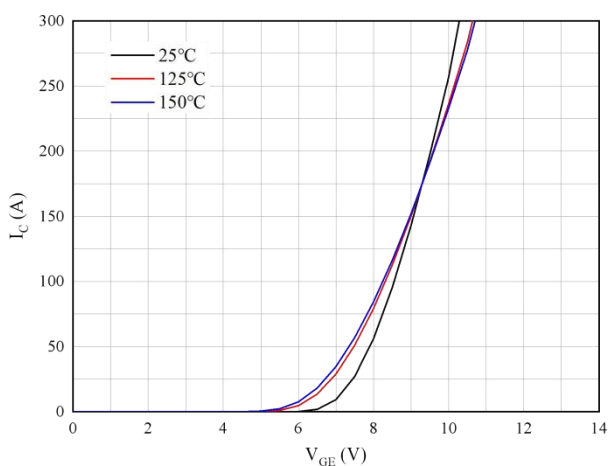


Fig 3. Typical transfer characteristic ($V_{CE}=20V$)

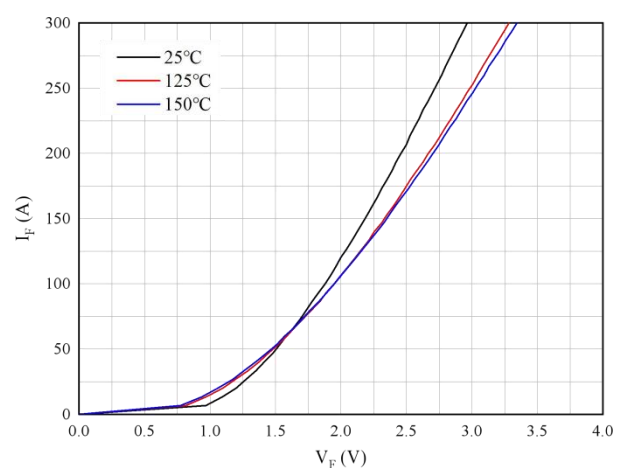


Fig 4. Forward characteristic of Diode

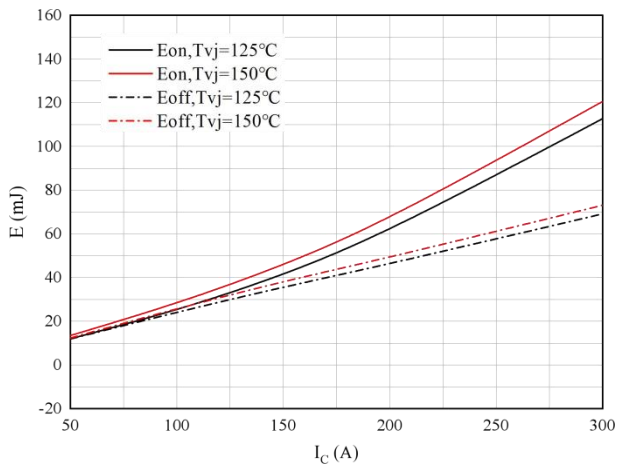


Fig 5. Switching losses of IGBT
 $V_{GE}=\pm 15\text{V}$, $R_{Gon}=4.8\Omega$, $R_{Goff}=4.8\Omega$, $V_{CE}=900\text{V}$

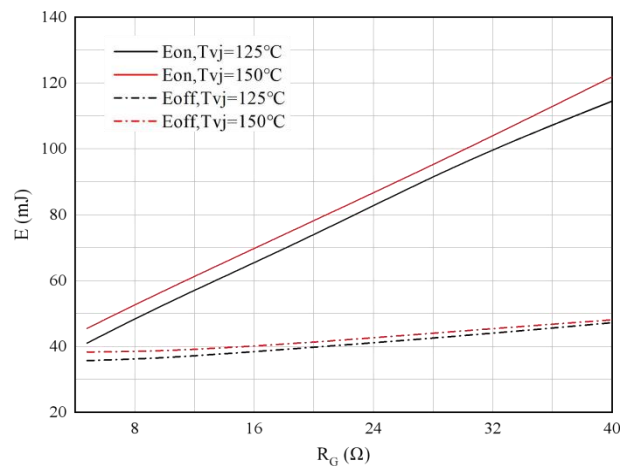


Fig 6. Switching losses of IGBT
 $V_{GE}=\pm 15\text{V}$, $I_C=150\text{A}$, $V_{CE}=900\text{V}$

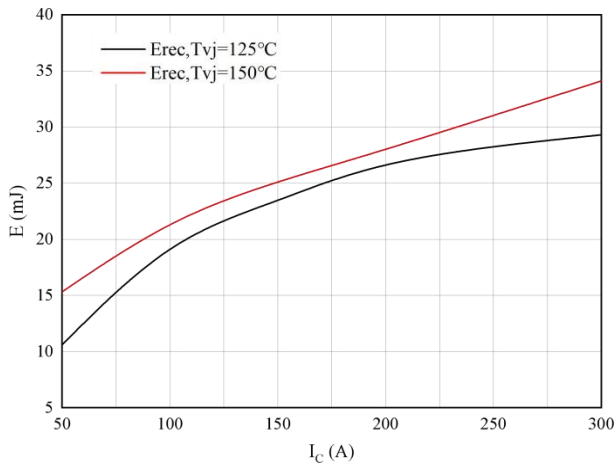


Fig 7. Switching losses of Diode
 $R_{Gon}=4.8\Omega$, $V_{CE}=900\text{V}$

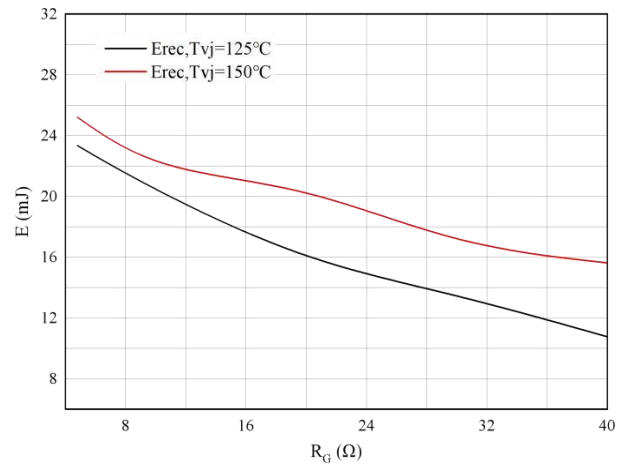


Fig 8. Switching losses of Diode
 $I_F=150\text{A}$, $V_{CE}=900\text{V}$

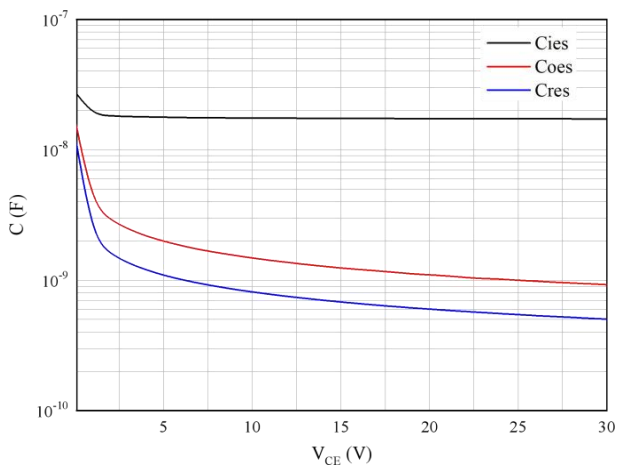
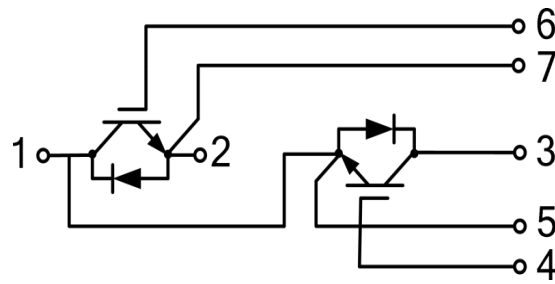
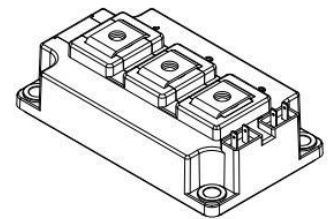
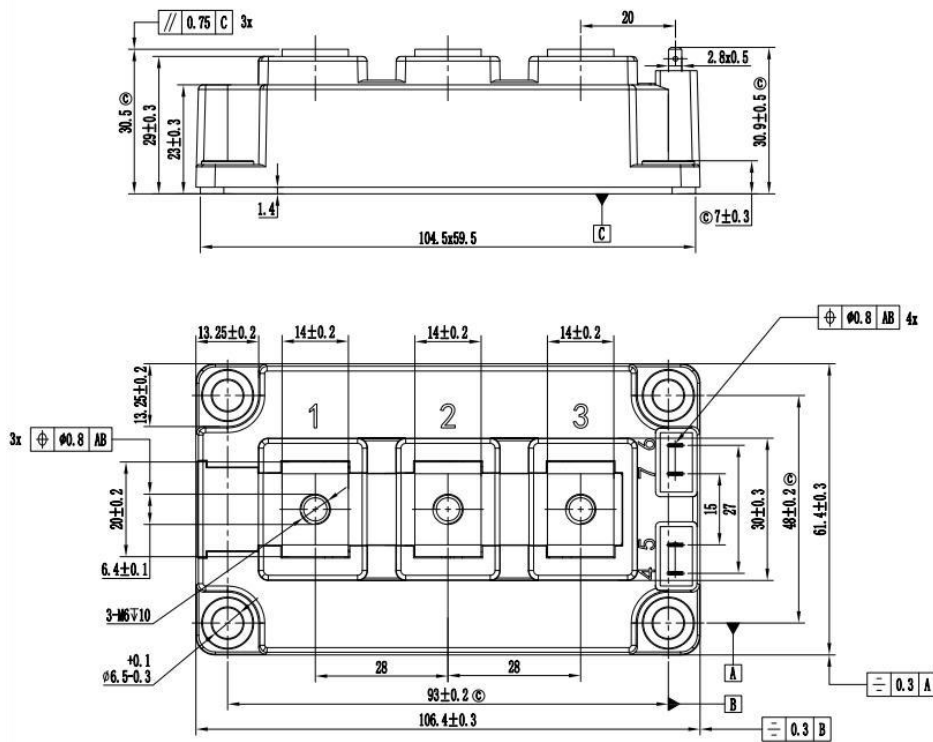


Fig 9. Capacitance characteristic

Circuit Diagram



Package Outlines(Unit: mm)



***Important Usage Information and Disclaimer**

The specifications of Zhuhai Hypersemi Co., Ltd. products are not guarantees of product characteristics. They reflect typical performance expected in standard applications, which may vary with specific uses. Users must conduct prior testing for their applications and make necessary adjustments.

Users are responsible for the safety of applications utilizing our products and must implement adequate safety measures to prevent physical injury, fire, or other risks in case of product failure. It is the user's duty to ensure that application designs comply with all applicable laws and standards. Our products must not be used in any applications where a product failure could reasonably result in personal injury, unless specifically authorized in a signed document by Zhuhai Hypersemi Co., Ltd.

No representations or warranties are made regarding the accuracy or completeness of this information, including any claims of non-infringement of third-party intellectual property rights. Zhuhai Hypersemi Co., Ltd. assumes no liability for any applications or uses of its products and does not grant any licenses to its intellectual property rights or those of others. We also make no claims regarding non-infringement of third-party intellectual property rights that may arise from applications.

Due to technical requirements, our products may contain hazardous substances. For details, please contact your nearest sales office. This document replaces all previous information and may be updated. We reserve the right to make changes.